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April 1st, 2010
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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User's Manual

QB-78K0KX2

In-Circuit Emulator

Target Devices

78K0/KB2

78K0/KC2

78K0/KD2

78K0/KE2

78K0/KF2

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[MEMO]

General Precautions for Handling This Product

1. Circumstances not covered by product guarantee

- If the product was disassembled, altered, or repaired by the customer
- If it was dropped, broken, or given another strong shock
- Use at overvoltage, use outside guaranteed temperature range, storing outside guaranteed temperature range
- If power was turned on while connection to the AC adapter, USB interface cable, or target system was in an unsatisfactory state
- If the cable of the AC adapter, the USB interface cable, the emulation probe, or the like was bent or pulled excessively
- If an AC adapter other than the supplied product was used
- If the product got wet
- If this product is connected to the target system when there is a potential difference between the GND of this product and GND of the target system.
- If the connectors or cables are plugged/unplugged while this product is in the power-on state.
- If excessive load is applied to the connectors or sockets (As for handling, please see **2.5 Mounting and Connecting Connectors**).
- If the product is used or stored in an environment where an electrostatic or electrical noise is likely to occur

2. Safety precautions

- If used for a long time, the product may become hot (50°C to 60°C). Be careful of low temperature burns and other dangers due to the product becoming hot.
- Be careful of electrical shock. There is a danger of electrical shock if the product is used as described above in **1 Circumstances not covered by product guarantee**.

INTRODUCTION

Readers This manual is intended for users who wish to perform debugging using the QB-78K0KX2. The readers of this manual are assumed to be familiar with the device functions and usage, and to have knowledge of debuggers.

Purpose This manual is intended to give users an understanding of the basic specifications and correct usage of the QB-78K0KX2.

Organization This manual is divided into the following sections.

- General
- Setup procedure
- Settings at product shipment
- Differences between target interface circuit and target device
- Notes

How to Read This Manual It is assumed that the readers of this manual have general knowledge in the fields of electrical engineering, logic circuits, and microcontrollers.

This manual describes the basic setup procedures and how to set switches.

To understand the overall functions and usages of the QB-78K0KX2

→Read this manual according to the **CONTENTS**. The mark <R> shows major revised points. The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

To know the manipulations, command functions, and other software-related settings of the QB-78K0KX2

→See the user's manual of the debugger (supplied with the QB-78K0KX2) to be used.

Conventions

Note: Footnote for item marked with **Note** in the text

Caution: Information requiring particular attention

Remark: Supplementary information

Numeric representation: Binary ... xxxx or xxxxB

Decimal ... xxxx

Hexadecimal ... xxxxH

Prefix indicating power of 2

(address space, memory

capacity):

K (kilo): $2^{10} = 1,024$

M (mega): $2^{20} = 1,024^2$

Terminology

The meanings of the terms used in this manual are described in the table below.

| Term | Meaning |
|---------------|---|
| Target device | This is the device to be emulated. |
| Target system | This is the system to be debugged. This includes the target program and the hardware provided by the user. |
| 78K0/Kx2 | Generic name indicating 78K0/KB2, 78K0/KC2, 78K0/KD2, 78K0/KE2, and 78K0/KF2. |
| IECUBE™ | Generic name for NEC Electronics' high-performance/compact in-circuit emulator. |

Related Documents

Please use the following documents in conjunction with this manual.

The related documents listed below may include preliminary versions. However, preliminary versions are not marked as such.

Documents Related to Development Tools (User's Manuals)

| Document Name | | Document Number |
|---|------------------------------|-----------------|
| QB-78K0KX2 In-Circuit Emulator | | This manual |
| RA78K0 Assembler Package Ver. 3.80 | Operation | U17199E |
| | Language | U17198E |
| | Structured Assembly Language | U17197E |
| CC78K0 C Compiler Ver. 3.70 | Operation | U17201E |
| | Language | U17200E |
| ID78K0-QB Ver. 2.90 Integrated Debugger | Operation | U17437E |
| PM plus Ver. 5.20 | | U16934E |

Caution The related documents listed above are subject to change without notice. Be sure to use the latest version of each document for designing, etc.

CONTENTS

| | |
|---|-----------|
| CHAPTER 1 GENERAL | 9 |
| 1.1 Hardware Specifications | 10 |
| 1.2 System Specifications..... | 11 |
| 1.3 System Configuration | 12 |
| 1.4 Package Contents | 16 |
| CHAPTER 2 SETUP PROCEDURE | 19 |
| 2.1 Names and Functions of Hardware..... | 20 |
| 2.2 Removal of Acrylic Board | 22 |
| 2.3 Clock Settings..... | 22 |
| 2.3.1 Overview of clock settings | 22 |
| 2.3.2 Clock setting methods | 23 |
| 2.3.3 Main system clock..... | 23 |
| 2.3.4 Subsystem clock | 25 |
| 2.4 Software Settings | 25 |
| 2.5 Mounting and Connecting Connectors | 25 |
| 2.5.1 Mounting NQ in target system | 25 |
| 2.5.2 Mounting YQ on NQ..... | 26 |
| 2.5.3 Plugging EA into YQ..... | 27 |
| 2.5.4 Notes on handling NQ, YQ, and YS | 27 |
| 2.5.5 Notes on mounting NQ and IC | 28 |
| 2.6 Connecting QB-78K0KX2 to Target System | 28 |
| 2.7 Notes on Power Supply and GND Pin Connection | 32 |
| 2.8 Connecting USB Interface Cable and AC Adapter..... | 32 |
| 2.9 Switching Power On and Off | 32 |
| CHAPTER 3 SETTINGS AT PRODUCT SHIPMENT | 33 |
| CHAPTER 4 DIFFERENCES BETWEEN TARGET INTERFACE CIRCUIT AND TARGET DEVICE | 34 |
| 4.1 For 78K0/KB2 Emulation..... | 35 |
| 4.2 For 78K0/KC2 Emulation..... | 37 |
| 4.3 For 78K0/KD2 Emulation..... | 39 |
| 4.4 For 78K0/KE2 Emulation | 41 |
| 4.5 For 78K0/KF2 Emulation | 43 |
| CHAPTER 5 NOTES | 45 |
| APPENDIX A REVISION HISTORY | 46 |

CHAPTER 1 GENERAL

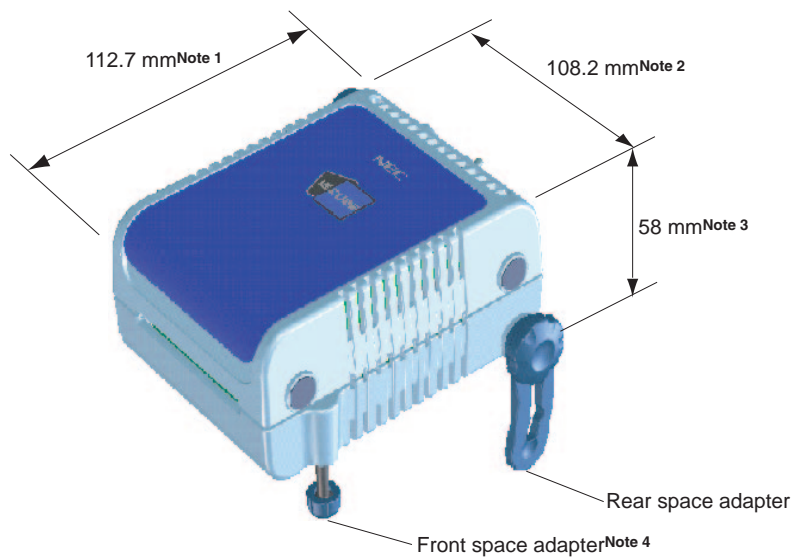
The QB-78K0KX2 is an in-circuit emulator for emulating the 78K0/Kx2.

Hardware and software can be debugged efficiently in the development of systems in which the 78K0/Kx2 is used. This manual describes basic setup procedures, hardware specifications, system specifications, and how to set switches.

1.1 Hardware Specifications

Table 1-1. QB-78K0KX2 Hardware Specifications

| Parameter | | Specification |
|-----------------------------|----------------------------|---|
| Target device | | 78K0/KB2, 78K0/KC2, 78K0/KD2, 78K0/KE2, 78K0/KF2 |
| Operating voltage | | 1.8 to 5.5 V |
| Operating frequency | Main system clock | V _{DD} = 4.0 to 5.5 V: 20 MHz V _{DD} = 2.7 to 5.5 V: 10 MHz V _{DD} = 1.8 to 5.5 V: 5 MHz |
| | Internal oscillation clock | Internal high-speed oscillation clock V _{DD} = 2.7 to 5.5 V: 8 MHz (TYP.) Internal low-speed oscillation clock V _{DD} = 2.7 to 5.5 V: 240 kHz (TYP.) (120 to 480 kHz) |
| | Subsystem clock | V _{DD} = 1.8 to 5.5 V: 32.768 kHz |
| Operating temperature range | | 0 to 40°C (No condensation) |
| Storage temperature range | | -15 to 60°C (No condensation) |
| External dimensions | | See figure below |
| Power consumption | AC adapter for QB-78K0KX2 | 15 V, 1 A |
| | Target system power supply | Voltage: 1.8 to 5.5 V Current: target device's current consumption + 10 mA (approx.) |
| Weight | | 300 g |
| Host interface | | USB interface (1.1, 2.0) |



- Notes**
1. Does not include projection of power switch
 2. Includes projection of screw that fixes rear space adapter
 3. Dimension when rear space adapter is made shortest (88 mm when longest)
 4. Front space adapter can vary from 20 mm (longest) to 5 mm (shortest)

1.2 System Specifications

This section shows the QB-78K0KX2 system specifications.

Table 1-2. QB-78K0KX2 System Specifications

| Parameter | | Specification |
|-----------------------------------|----------------------------------|--|
| Emulation memory capacity | Internal ROM | 128 KB (MAX.) |
| | Internal high-speed ROM | 1 KB (MAX.) |
| | Internal expansion RAM | 6 KB (MAX.) |
| Program execution functions | Real-time execution function | Go, Start from Here, Go & Go, Come Here, Restart, Return Out, Ignore break points and Go |
| | Non-real-time execution function | Step execution |
| Break functions | Event break | Execution: 8 points Access: Byte 8 points, word 2 points |
| | Software break | 2000 points |
| | Pre-execution break | 16 points |
| | Fail-safe break | Exists |
| | Other | Forcible break, trace full break, trace delay break, timeout break, timer overflow break |
| Trace functions | Trace data types | Program address, program data, access address, access data, status |
| | Trace modes | Full trace, section trace, qualify trace |
| | Trace functions | Delay function, full stop function |
| | Memory capacity | 128K frames |
| Real-time RAM monitoring function | | All spaces |
| Time measurement functions | Measurement clock | 50 MHz or CPU clock |
| | Measurement objects | Beginning through end of program execution Start event through end event |
| | Maximum measurement time | Approximately 48 hours and 50 minutes (Resolution 41 μ s) |
| | Minimum resolution | 20 ns (Measuring time: 85 seconds) |
| | Number of timers for measurement | Start through end of program execution: 1 Start event through end event: 2 |
| | Measurement results | Maximum, minimum, average, cumulative, number of passes (between events) |
| | Other | Timer overflow break function, timeout break function |
| Other functions | | Mapping function, event function, coverage function, snapshot function, DMM function, stub function, power-off emulation function, pin mask function |

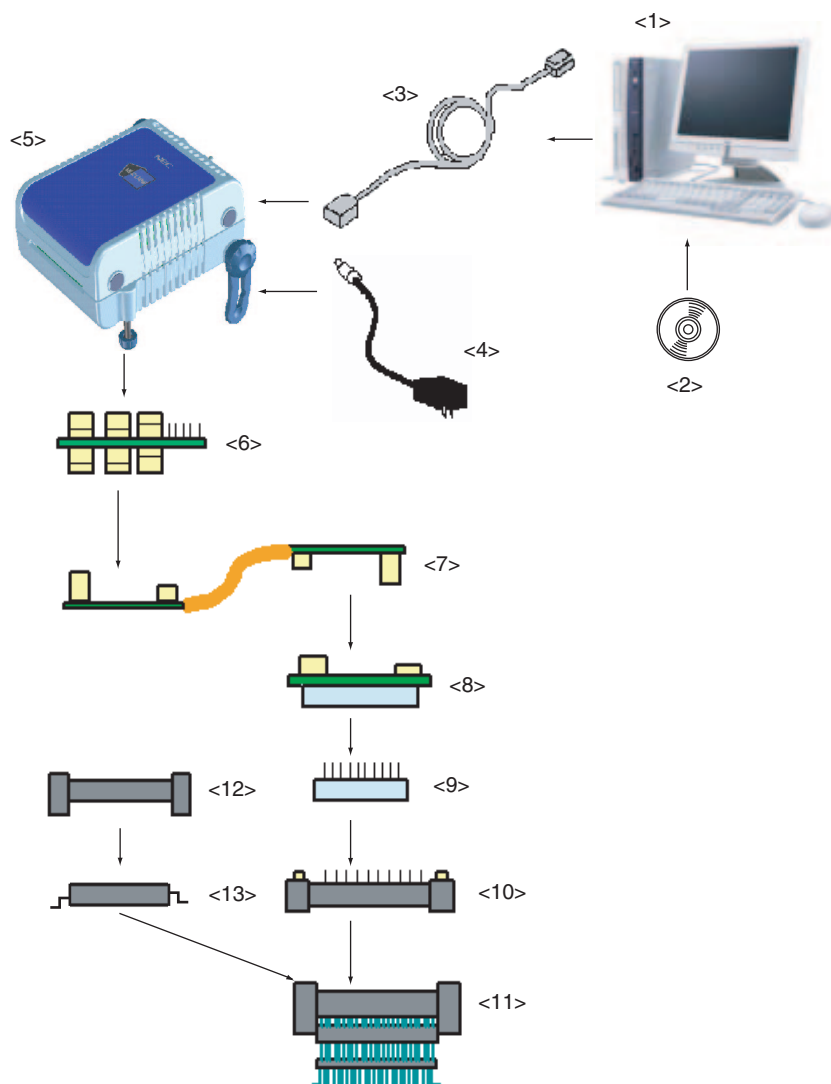
1.3 System Configuration

This section shows the system configuration when using the QB-78K0KX2 connected to a PC (PC-9821 series, PC/AT™ compatible). Connection is possible even without optional products.

Table 1-3. Devices Subject to Emulation by 78K0/Kx2

| Device Name (Common Name) | Package | Device Name |
|------------------------------|--------------------------|---|
| | | Flash Memory Version |
| 78K0/KB2 | 30-pin SSOP (MC) | μ PD78F0500, μ PD78F0501, μ PD78F0502, μ PD78F0503, μ PD78F0503D |
| | 36-pin FLGA (FC) | |
| 78K0/KC2 | 44-pin LQFP (GB) | μ PD78F0511, μ PD78F0512, μ PD78F0513, μ PD78F0513D |
| | 48-pin LQFP (GA) | μ PD78F0511, μ PD78F0512, μ PD78F0513, μ PD78F0514, μ PD78F0515, μ PD78F0515D |
| 78K0/KD2 | 52-pin LQFP (GB) | μ PD78F0521, μ PD78F0522, μ PD78F0523, μ PD78F0524, μ PD78F0525, μ PD78F0526, μ PD78F0527, μ PD78F0527D |
| 78K0/KE2 | 64-pin LQFP (GB, GC, GK) | μ PD78F0531, μ PD78F0532, μ PD78F0533, μ PD78F0534, μ PD78F0535, μ PD78F0536, μ PD78F0537, μ PD78F0537D |
| | 64-pin TQFP (GA) | |
| | 64-pin FLGA (FC) | |
| 78K0/KF2 | 80-pin LQFP (GC, GK) | μ PD78F0544, μ PD78F0545, μ PD78F0546, μ PD78F0547, μ PD78F0547D |

Figure 1-1. System Configuration



- | | |
|---|---|
| <p><1> Host machine:</p> <p><2> ID78K0-QB Disk/Accessory Disk^{Note1}:</p> <p><3> USB interface cable:</p> <p><4> AC adapter:</p> <p><5> QB-78K0KX2:</p> <p><6> Check pin adapter^{Note2}:</p> <p><7> Emulation probe:</p> <p><8> Exchange adapter^{Note3}:</p> <p><9> Space adapter^{Note3}:</p> <p><10> YQ connector^{Note3}:</p> <p><11> Target connector^{Note3}:</p> <p><12> Mount adapter^{Note3}:</p> <p><13> Device</p> | <p>PC-9821 series, PC/AT compatible can be used Debugger, USB drivers, manual, etc.</p> <p>Cable connecting QB-78K0KX2 to host machine</p> <p>Can support 100 to 240 V by replacing AC plug This product</p> <p>Adapter used when observing waveforms on oscilloscope</p> <p>Flexible type of emulation probe</p> <p>Adapter that performs pin conversion</p> <p>Adapter for height regulation</p> <p>Connector that connects exchange adapter to target connector</p> <p>Connector soldered to target system</p> <p>Adapter for socket mounting target device</p> <p>Target device</p> |
|---|---|

Refer to 1.4 **Package Contents** for the purchase forms of the above products.

- Notes 1.** Obtain device files from the NEC Electronics website.
<http://www.necel.com/micro/ods/eng/index.html>
- 2.** Please refer to **[Related Information]** on the following URL about attachment method for pin header cover.
<http://www.necel.com/micro/english/iecube/index.html>
- 3.** As for handling of connectors, refer to **2.5 Mounting and Connecting Connectors.**

Table 1-4. Check Pin Adapters

| Package | Check Pin Adapter |
|---------|-------------------|
| Common | QB-144-CA-01 |

Table 1-5. Exchange Adapters

| Package | Exchange Adapter |
|---------|------------------|
| 80GC | QB-80GC-EA-01T |
| 80GK | QB-80GK-EA-01T |
| 64FC | QB-64FC-EA-01T |
| 64GA | QB-64GA-EA-01T |
| 64GB | QB-64GB-EA-04T |
| 64GC | QB-64GC-EA-03T |
| 64GK | QB-64GK-EA-04T |
| 52GB | QB-52GB-EA-02T |
| 48GA | QB-48GA-EA-02T |
| 44GB | QB-44GB-EA-03T |
| 36FC | QB-36FC-EA-01T |
| 30MC | QB-30MC-EA-02T |

Table 1-6 Emulation Probes

| Package | Emulation Probe |
|---------|-----------------|
| Common | QB-80-EP-01T |

Table 1-7. YQ Connectors

| Package | YQ Connector |
|---------|----------------|
| 80GC | QB-80GC-YQ-01T |
| 80GK | QB-80GK-YQ-01T |
| 64FC | _ Note |
| 64GA | QB-64GA-YQ-01T |
| 64GB | QB-64GB-YQ-01T |
| 64GC | QB-64GC-YQ-01T |
| 64GK | QB-64GK-YQ-01T |
| 52GB | QB-52GB-YQ-01T |
| 48GA | QB-48GA-YQ-01T |
| 44GB | QB-44GB-YQ-01T |
| 36FC | _ Note |
| 30MC | QB-30MC-YQ-01T |

Note Both 36FC and 64FC do not have YQ connectors, space adapters, and mount adapters.

Table 1-8 Space Adapters

| Package | Space Adapter |
|---------|----------------|
| 80GC | QB-80GC-YS-01T |
| 80GK | QB-80GK-YS-01T |
| 64FC | _Note |
| 64GA | QB-64GA-YS-01T |
| 64GB | QB-64GB-YS-01T |
| 64GC | QB-64GC-YS-01T |
| 64GK | QB-64GK-YS-01T |
| 52GB | QB-52GB-YS-01T |
| 48GA | QB-48GA-YS-01T |
| 44GB | QB-44GB-YS-01T |
| 36FC | _Note |
| 30MC | QB-30MC-YS-01T |

Table 1-9. Target Connectors

| Package | Target Connector |
|---------|------------------|
| 80GC | QB-80GC-NQ-01T |
| 80GK | QB-80GK-NQ-01T |
| 64FC | QB-64FC-NQ-01T |
| 64GA | QB-64GA-NQ-01T |
| 64GB | QB-64GB-NQ-01T |
| 64GC | QB-64GC-NQ-01T |
| 64GK | QB-64GK-NQ-01T |
| 52GB | QB-52GB-NQ-01T |
| 48GA | QB-48GA-NQ-01T |
| 44GB | QB-44GB-NQ-01T |
| 36FC | QB-36FC-NQ-01T |
| 30MC | QB-30MC-NQ-01T |

Note Both 36FC and 64FC do not have YQ connectors, space adapters, and mount adapters.

<R>

Table 1-10. Mount Adapters

| Package | Mount Adapter |
|---------|----------------|
| 80GC | QB-80GC-HQ-01T |
| 80GK | QB-80GK-HQ-01T |
| 64FC | _Note |
| 64GA | QB-64GA-HQ-01T |
| 64GB | QB-64GB-HQ-01T |
| 64GC | QB-64GC-HQ-01T |
| 64GK | QB-64GK-HQ-01T |
| 52GB | QB-52GB-HQ-01T |
| 48GA | QB-48GA-HQ-01T |
| 44GB | QB-44GB-HQ-01T |
| 30MC | _Note |
| 30MC | QB-30MC-HQ-01T |

Note Both 36FC and 64FC do not have YQ connectors, space adapters, and mount adapters.

Remark For notes on target system design and package drawings, refer to [Related Information] on the following URL.
<http://www.necel.com/micro/english/iecube/index.html>

1.4 Package Contents

The following items have been placed in the QB-78K0KX2 packing box. Please check the contents.

Products supplied with QB-78K0KX2-ZZZ

- 1: QB-78K0KX2
- 2: AC adapter
- 3: USB interface cable (2 meters)
- 4: User registration
- 5: Simplified flash programmer (PG-FPL3 or QB-MINI2)
- 6: ID78K0-QB Disk (CD-ROM)
- 7: Accessory Disk (CD-ROM)
- 8: IECUBE Setup Manual

Products supplied with QB-78K0KX2-T80GC

- 1 to 8
- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-80GC-EA-01T
- 11: YQ connector QB-80GC-YQ-01T
- 12: Target connector QB-80GC-NQ-01T

Products supplied with QB-78K0KX2-T80GK

- 1 to 8
- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-80GK-EA-01T
- 11: YQ connector QB-80GK-YQ-01T
- 12: Target connector QB-80GK-NQ-01T

Products supplied with QB-78K0KX2-T64FC

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-64FC-EA-01T
- 12: Target connector QB-64FC-NQ-01T

Products supplied with QB-78K0KX2-T64GA

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-64GA-EA-01T
- 11: YQ connector QB-64GA-YQ-01T
- 12: Target connector QB-64GA-NQ-01T

Products supplied with QB-78K0KX2-T64GB

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-64GB-EA-04T
- 11: YQ connector QB-64GB-YQ-01T
- 12: Target connector QB-64GB-NQ-01T

Products supplied with QB-78K0KX2-T64GC

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-64GC-EA-03T
- 11: YQ connector QB-64GC-YQ-01T
- 12: Target connector QB-64GC-NQ-01T

<R>

Products supplied with QB-78K0KX2-T64GK

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-64GK-EA-04T
- 11: YQ connector QB-64GK-YQ-01T
- 12: Target connector QB-64GK-NQ-01T

Products supplied with QB-78K0KX2-T52GB

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-52GB-EA-02T
- 11: YQ connector QB-52GB-YQ-01T
- 12: Target connector QB-52GB-NQ-01T

Products supplied with QB-78K0KX2-T48GA

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-48GA-EA-02T
- 11: YQ connector QB-48GA-YQ-01T
- 12: Target connector QB-48GA-NQ-01T

Products supplied with QB-78K0KX2-T44GB

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-44GB-EA-03T
- 11: YQ connector QB-44GB-YQ-01T
- 12: Target connector QB-44GB-NQ-01T

Products supplied with QB-78K0KX2-T36FC

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-36FC-EA-01T
- 12: Target connector QB-36FC-NQ-01T

Products supplied with QB-78K0KX2-T30MC

1 to 8

- 9: Emulation probe QB-80-EP-01T
- 10: Exchange adapter QB-30MC-EA-02T
- 11: YQ connector QB-30MC-YQ-01T
- 12: Target connector QB-30MC-NQ-01T

The following products are sold as single items.

- Emulation probe
- Exchange adapter
- YQ connector^{Note}
- Target connector
- Check pin adapter
- Space adapter^{Note}
- Mount adapter^{Note}

Note Both 36FC and 64FC do not have YQ connectors, space adapters, and mount adapters.

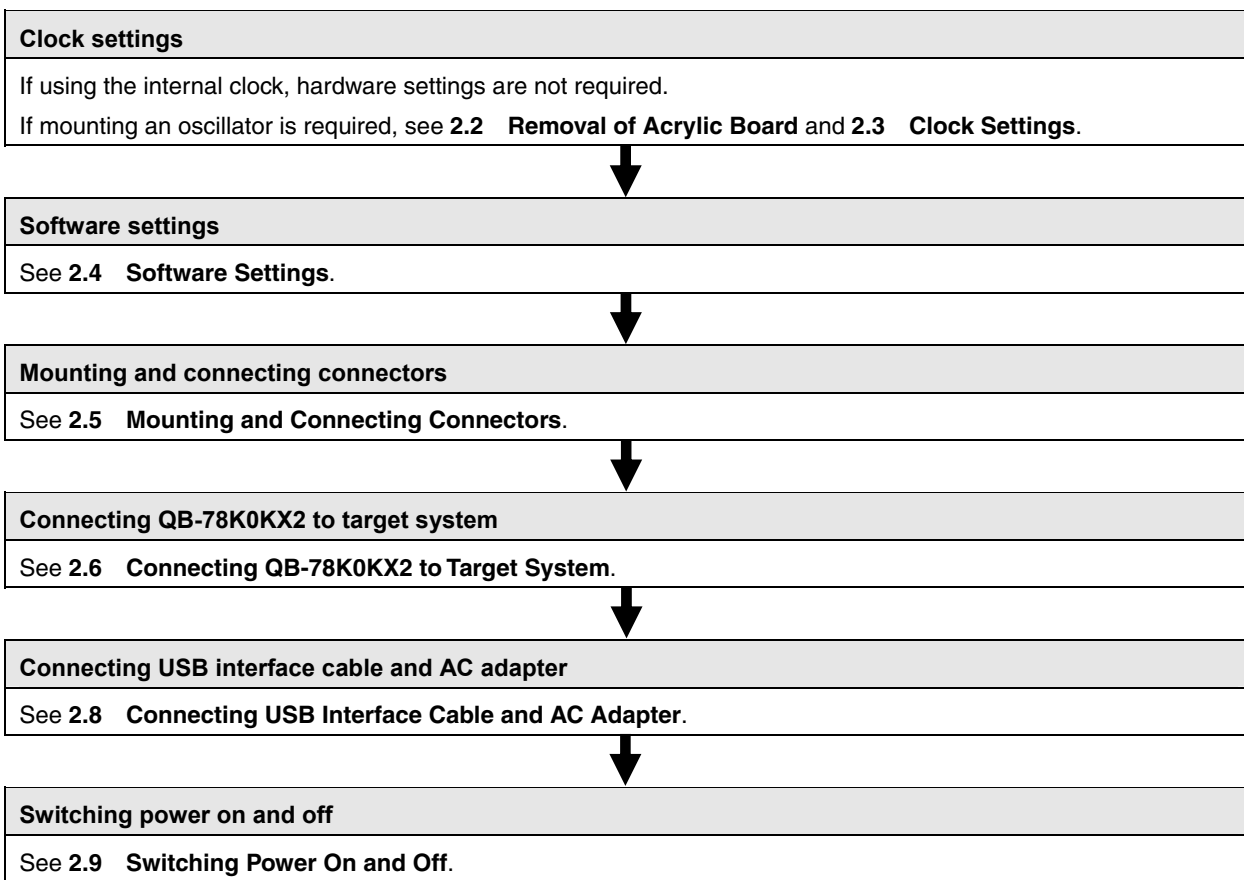
CHAPTER 2 SETUP PROCEDURE

This chapter explains the QB-78K0KX2 setup procedure.

Setup can be completed by performing installation setup in the order in which it appears in this chapter.

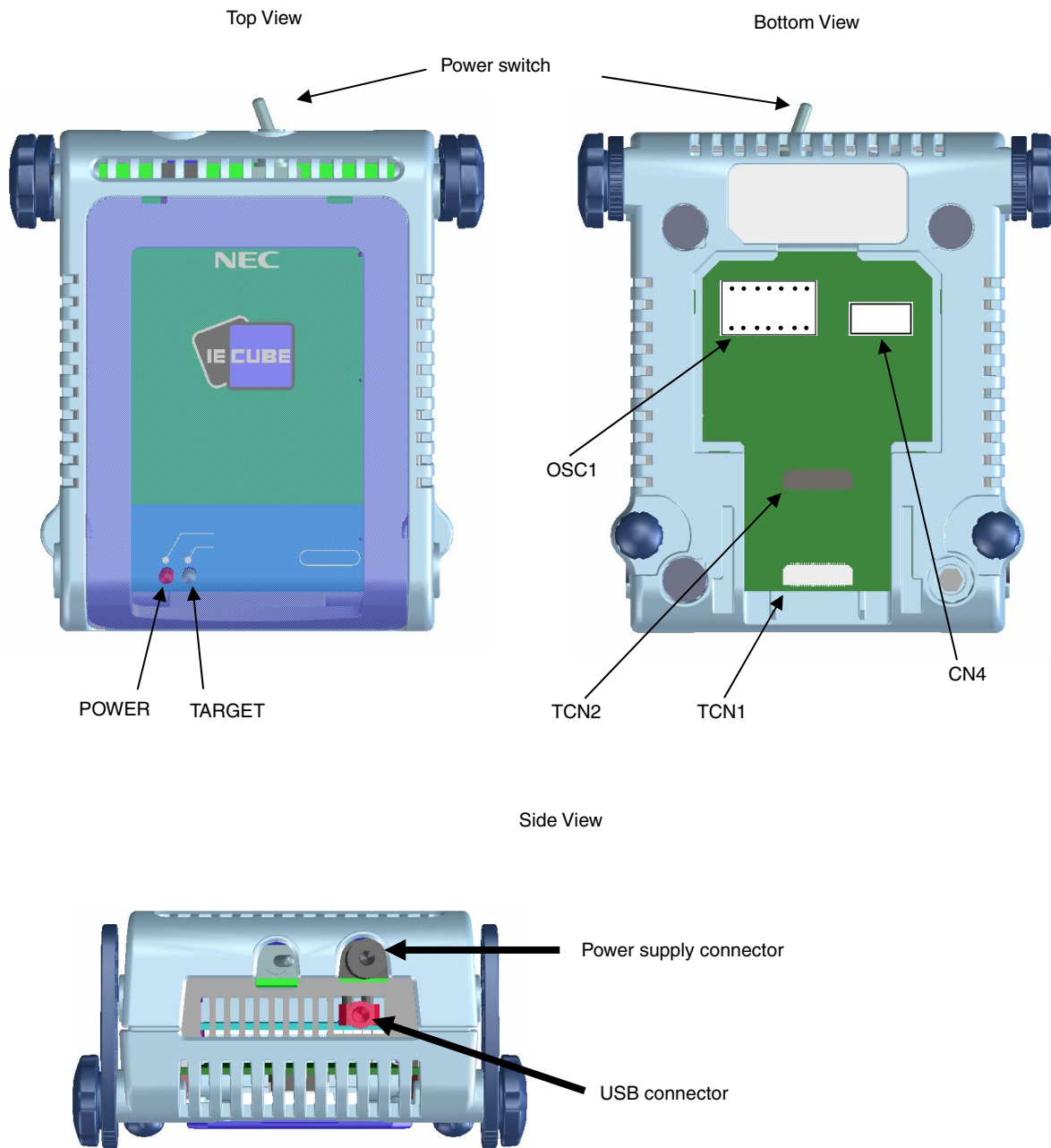
Perform setup along the lines of the following procedure.

See **2.1 Names and Functions of Hardware** for clock board positions.



2.1 Names and Functions of Hardware

Figure 2-1. Names of Parts of QB-78K0KX2



(1) TCN1, TCN2

These are connectors for connecting a check pin adapter or emulation probe.

(2) OSC1

This is a socket for mounting the oscillator.

(3) CN4^{Note}

This is a connector for the shipment inspection.

Note It is not necessary for user to use CN4.

(4) POWER (Red LED)

This is an LED that shows whether or not the power supply of the QB-78K0KX2 is switched on.

| LED State | QB-78K0KX2 State |
|-----------|--|
| Lit | Power switch ON |
| Not lit | Power switch OFF or AC adapter not connected to QB-78K0KX2 |
| Blinking | Internal error occurred (Contact an NEC Electronics sales representative or distributor) |

(5) TARGET (Green LED)

This is an LED that shows whether or not the power supply of the target system is switched on.

| LED State | Target System State |
|-----------|---|
| Lit | Target system power supply ON |
| Not lit | Target system power supply OFF or target system not connected |

(6) Power switch

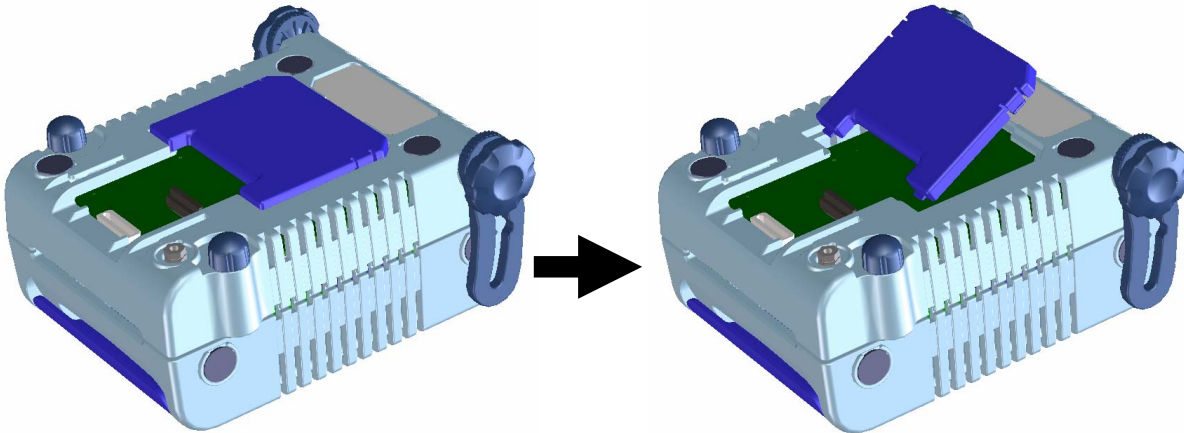
This is the power switch of the QB-78K0KX2.

It is OFF at shipment.

2.2 Removal of Acrylic Board

To modify the clock setting, the acrylic board on the bottom of the QB-78K0KX2 must be removed. The acrylic board can be removed by lifting it up.

Figure 2-2. Acrylic Board Removal Method



<R> 2.3 Clock Settings

2.3.1 Overview of clock settings

The following 5 types of clock settings are available.

For details, see **2.3.2 Clock setting methods**.

Main system clock:

- (1) Using the clock generated in the emulator (with high-speed internal oscillator used)
- (2) Supplying a clock (square wave) from the target system
- (3) Using the oscillator (OSC1) mounted in the emulator

Subsystem clock:

- (1) Using the clock generated in the emulator
- (2) Supplying a clock (square wave) from the target system

2.3.2 Clock setting methods

This section shows the clock settings.

Table 2-1. Main System Clock Setting

| Type of Clock to Be Used | OSC1 | Debugger Setting |
|--|------------------|------------------|
| (1) Using the clock generated in the emulator (with high-speed internal oscillator used) | – | System |
| (2) Suppling a clock (square wave) from the target system ^{Note} | – | External |
| (3) Using the oscillator (OSC1) mounted in the emulator | Mount oscillator | Clock Board |

Note Do not select this setting when the TARGET LED is not lit.

Remarks 1. Settings other than those above are prohibited.

2. Selection of (1) or (2) is possible regardless of whether or not the oscillator is mounted onto OSC1.

Table 2-2. Subsystem Clock Setting

| Type of Clock to Be Used | Remarks |
|---|----------|
| (1) Using the clock generated in the emulator | System |
| (2) Suppling a clock (square wave) from the target system ^{Note} | External |

Note Do not select this setting when the TARGET LED is not lit.

Remark Settings other than those above are prohibited.

2.3.3 Main system clock

(1) Using the clock generated in the emulator (with high-speed internal oscillator used)

Select “System” in the configuration dialog box of the debugger and select the desired frequency from the dialog menu.

(2) Suppling a clock (square wave) from the target system

Select “External” in the configuration dialog box of the debugger to use the clock input from the target system. To input the clock from the target system, input to the clock pin (X2) the square wave^{Note} with the same potential as the target device (inputting the inverted waveform to the X1 pin is unnecessary).

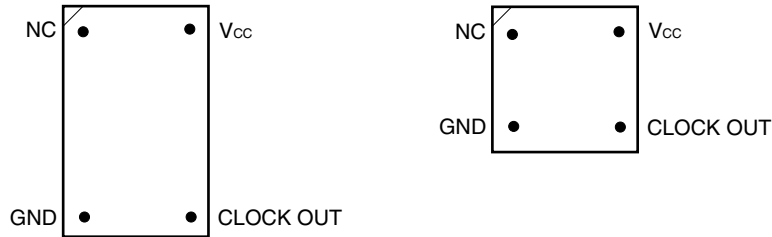
Note Square waves from oscillators using a resonator are not supported.

(3) Using the oscillator (OSC1) mounted in the emulator

◆ Things to prepare

- Oscillator^{Note} (with pins as shown in Figure 2-3 and a 5 V power supply)

Figure 2-3. Oscillator (Main System Clock)



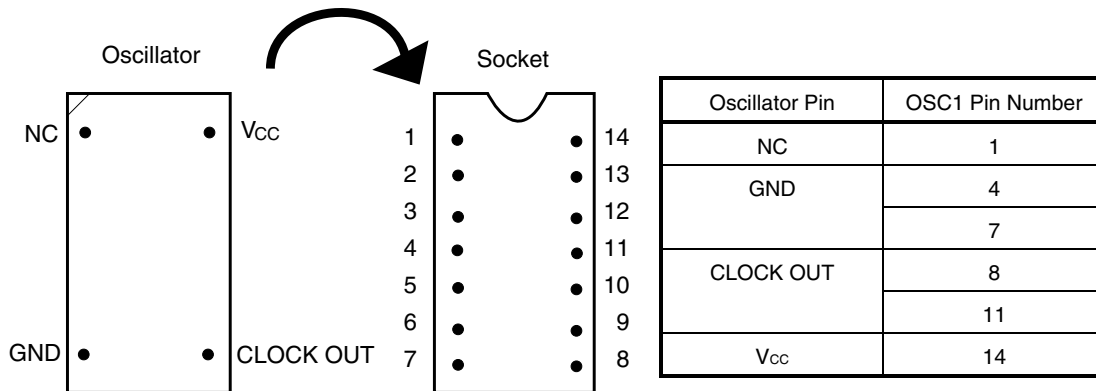
Top View

Note Oscillation circuits using resonators cannot be used.

<Procedure>

- <1> Mount the prepared oscillator onto OSC1. When mounting the oscillator onto OSC1, be sure to insert it in the direction of pin 1.

Figure 2-4. Alignment of Oscillator to Socket (Main System Clock)



- <2> Set the "Clock Board" in the configuration dialog box of the debugger.

For the frequency at this time, the clock of the oscillator mounted onto OSC1 is used.

2.3.4 Subsystem clock

(1) For mounting internally generated clock

Select “System” in the configuration dialog box of the debugger and select the desired frequency from the dialog menu.

(2) For using target system clock

Select “External” in the configuration dialog box of the debugger to use the clock input from the target system. To input the clock from the target system, input to the clock pin (XT2) the square wave with the same potential as the target device (inputting the inverted waveform to the XT1 pin is unnecessary).

2.4 Software Settings

For details, see the **ID78K0-QB Ver. 2.90 Integrated Debugger Operation User's Manual (U17437E)**.

2.5 Mounting and Connecting Connectors

This section describes the methods of connecting the QB-78K0KX2 and target system.

Make connections with both the QB-78K0KX2 and target system powered OFF.

The following abbreviations are used in this section.

- NQ: Target connector
- YQ: YQ connector
- EA: Exchange adapter
- HQ: Mount adapter
- CA: Check pin adapter
- YS: Space adapter

2.5.1 Mounting NQ in target system

- (1) Thinly apply a two-component epoxy adhesive (hardening time at least 30 minutes) to the ends of the four projections on the base of the NQ and adhere the NQ to the user board (clean the surface of the user board using alcohol or the like). If alignment of user board pads to NQ leads is difficult, align them as in (2).
- (2) Align by inserting the guide pins for alignment for the NQ (NQ-Guide) through the pin holes on the top of the NQ. Accessory holes are $\phi 1.0$ mm non-through holes in 2 or 3 places.
(For hole positions, see the particular NQ drawing.)
- (3) Solder after fitting the HQ to the NQ. This is to prevent troubles such as flux or solder splatter and adhering to the NQ contact pins when soldering.
 - Soldering conditions

| | |
|---------------------------------------|---|
| Solder reflow (FC package) | At 260°C for a maximum of 10 seconds |
| Solder reflow (except for FC package) | At 240°C for a maximum of 20 seconds |
| Manual soldering | At 240°C for a maximum of 10 seconds (1 pin) |

Caution Do not perform washing by flux immersion or vapor.

- (4) Take away the guide pins.

2.5.2 Mounting YQ on NQ

- (1) After confirming that there are no broken or bent YQ contact pins, fit the YQ in the NQ and fasten the screw. If repeatedly inserting and removing, be sure to inspect the YQ pins before fitting. If pins are bent, correct them using something thin and flat such as the edge of a knife.
- (2) Accessory holes are needed in prescribed positions in 4 places in the board for connecting the YQ. Fasten the YQ to the NQ on the user board using the supplied $M2 \times 10$ mm screws. The thickness of a board corresponding to these screws is 1.0 to 2.0 mm. Fasten the screws equally in the four corners using a No. 1 or No. 0 precision (+) driver or torque driver. The tightening torque of the screws is 0.054 Nm (MAX.). Too great tightening causes bad connections.
Screws for fitting to the NQ ($M2 \times 10$ mm/4) are included with the YQ.

2.5.3 Plugging EA into YQ

Match the No. 1 pin position of the YQ or YS (C cuts match in both) to the No. 1 pin position of the EA and plug in.

- When plugging or unplugging, press on the NQ, YQ, and YS with a finger so that there is no force on the NQ.
- When plugging or unplugging, be careful of the direction of rocking.

As a tool when unplugging, insert some kind of thin non-conductive material such as a wooden stick between the YQ (YS) and EA and rock while slowly unplugging. Be careful since the connector will be damaged if this is done in the wrong direction.

2.5.4 Notes on handling NQ, YQ, and YS

- (1) When taking the NQ from the box, press down on the body and take out the sponge first.
- (2) Since the pins of the YQ are thin and easily bent, be careful. When inserting it in the NQ, confirm that there are no bent pins.
- (3) When screwing a YQ soldered to a board to the NQ, fasten the screws in four places in turn using a No. 0 or No. 1 Phillips precision driver or torque driver after tentatively tightening them. Fix the torque at 0.054 Nm (MAX.). If just one place is overtightened, it may cause poor contact. Moreover, a board being connected to the YQ must have accessory holes in prescribed positions (4 places: $\phi 2.3$ mm or $\phi 3.3$ mm). The $\phi 3.8$ mm or $\phi 4.3$ mm that is the screw head size is an area where wiring is prohibited.
- (4) In YQ and YS removal, since there is a danger of YQ pins being bent or broken when prying and rocking, remove them gradually using a screwdriver from four directions. Moreover, to connect and use the YQ and YS, screw the YQ to the NQ according to the YQGUIDE (sold separately) using a 2.3 mm screwdriver and then connect it to the YS. Fix the torque at 0.054 Nm (MAX.). If even one place is overtightened, it may cause poor contact.
- (5) For the NQ, YQ, and YS, since there is a danger that washing fluid on the structure will remain in the connector, do not perform washing.
- (6) NQ, IC, and YQ cannot be used in combination.
- (7) An NQ/YQ system cannot be used in an environment of vibrations or shocks.
- (8) It is assumed that this product will be used in system development and evaluation. Moreover, when used in Japan, Electrical Appliance and Material Control Law and electromagnetic disturbance countermeasures have not been applied.
- (9) Since there are rare cases of shape change if the box is left for a long time in a place where it is 50°C or higher, for safekeeping, store it in a place where it is no higher than 40°C and direct sunlight does not hit it.
- (10) For details about handling the NQ, YQ, and YS, see the NQPACK series technical materials at the website of Tokyo Eletech Corporation.

Tokyo Eletech Corporation website: <http://www.tetc.co.jp/>

2.5.5 Notes on mounting NQ and IC

- (1) Confirm that there is no weld flash in the resin (sealant part) of the IC. If there is weld flash, remove it using a knife or the like.
- (2) Confirm that there is no weld flash breaking or bending of IC leads. In particular, confirm the planarity of IC leads. If there is abnormality in the planarity, correct that portion.
- (3) Viewing the NQ contact pins from the top, if there are foreign bodies on them, remove them using a brush or the like.

After confirming (1) to (3), fit the IC to the NQ. Also fit the HQ.

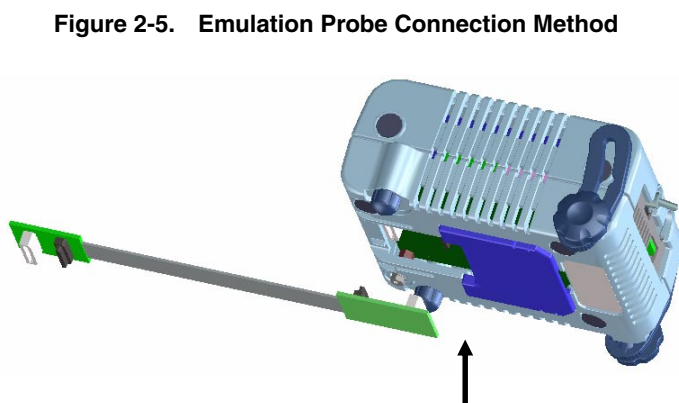
- (4) Put the supplied M2 × 6 mm screws in the 4 accessory holes of the HQ and fasten the screws in opposite corners. At that time, use either the dedicated screw driver that is supplied or a torque driver to fasten them equally in turn with a tightening torque of 0.054 Nm (MAX.). Since the contact is poor if tightening is too great, once you have lightly fastened the HQ screws, tighten them again.
- (5) Depending on the use environment, when starting up a device that has been left for a long time, starting it may be difficult. In this case, loosen the screws slightly and then retighten them.
- (6) If startup still is difficult after (5) above, check (1) to (3) again.
- (7) Tightening the screws of the HQ too much may give rise to cracks in the molded part of the HQ (plastic part) and bend the mold into a bowed shape, making contact poor.
- (8) After soldering the NQ, do not perform washing by flux immersion or vapor.

2.6 Connecting QB-78K0KX2 to Target System

If connecting the emulation probe (QB-80-EP-01T), connect it to the QB-78K0KX2 and the target system by the following procedure.

(a) Connection of emulation probe

Connect the emulation probe to the QB-78K0KX2.



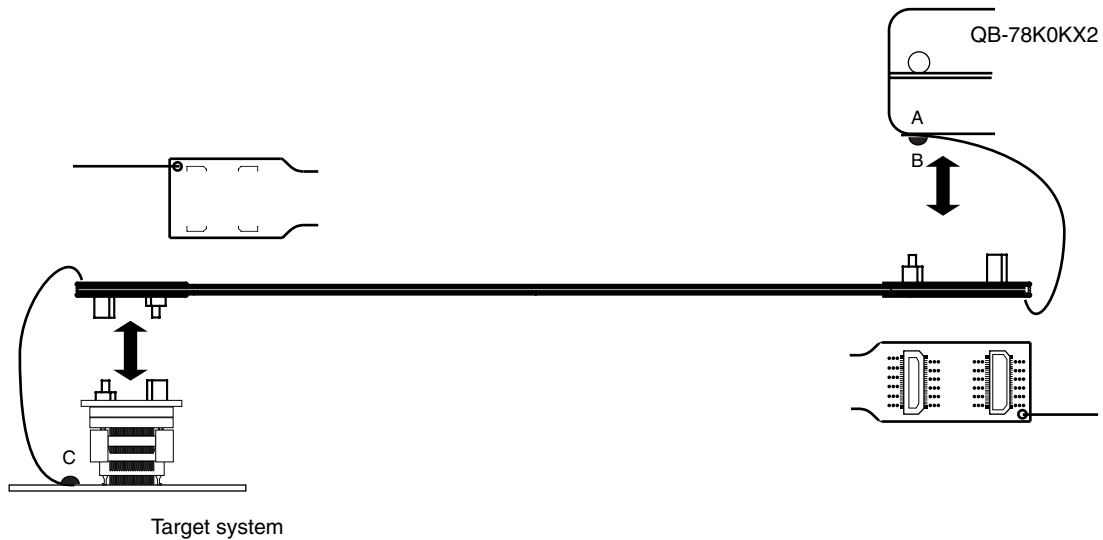
Insert CN1 and CN2 of the probe into TCN1 and TCN2 of the QB-78K0KX2.

(b) Connection of emulation probe GND wire

There are 2 GND wires in the emulation probe. Connect them to the QB-78K0KX2 and target system.

- <1> Fasten the GND wire on the QB-78K0KX2 side of the emulation probe to the nut on the bottom of the QB-78K0KX2 using a #0 or #1 Phillips precision driver (connection of B to A in Figure 2-6).
- <2> Next plug the connector on top of the emulation probe into the connector at the opening on the bottom of the QB-78K0KX2 from below being careful of the insertion direction.

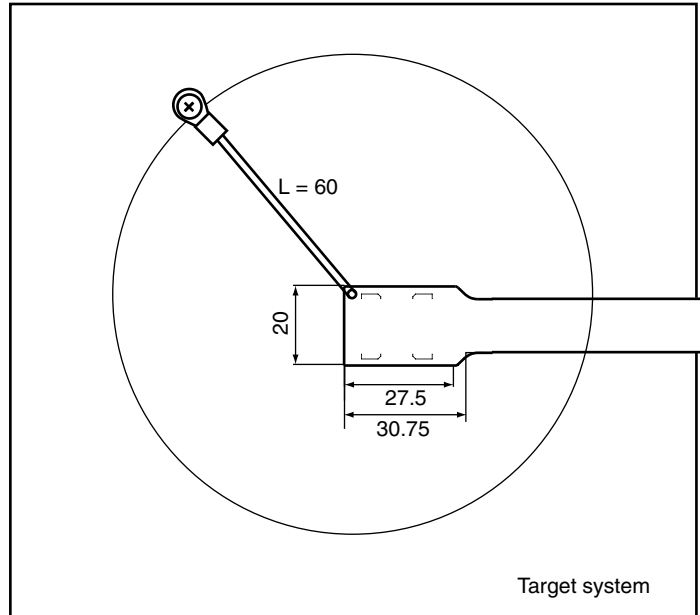
Figure 2-6. GND Wire



- <3> Connect the exchange adapter and emulation probe to the target connector.
- <4> Connect the GND wire on the target system side of the emulation probe to the target system GND. If a pin or screw is fastened to the target system GND, remove the transparent terminal cover on the end of the GND wire and fasten the Y terminal of the GND wire to the target system (C in Figure 2-6). If the GND on the target system is an exposed pad, likewise fasten the Y terminal to the pad on the target system by soldering (recommended soldering iron temperature setting: 300°C).

<5> Since the length of the GND wire below the head (insulated part) is approximately 60 mm, there must be a GND to which it can be connected to within the range of an approximately 60 mm radius section of the target system for connecting the emulation probe, as shown in Figure 2-7.

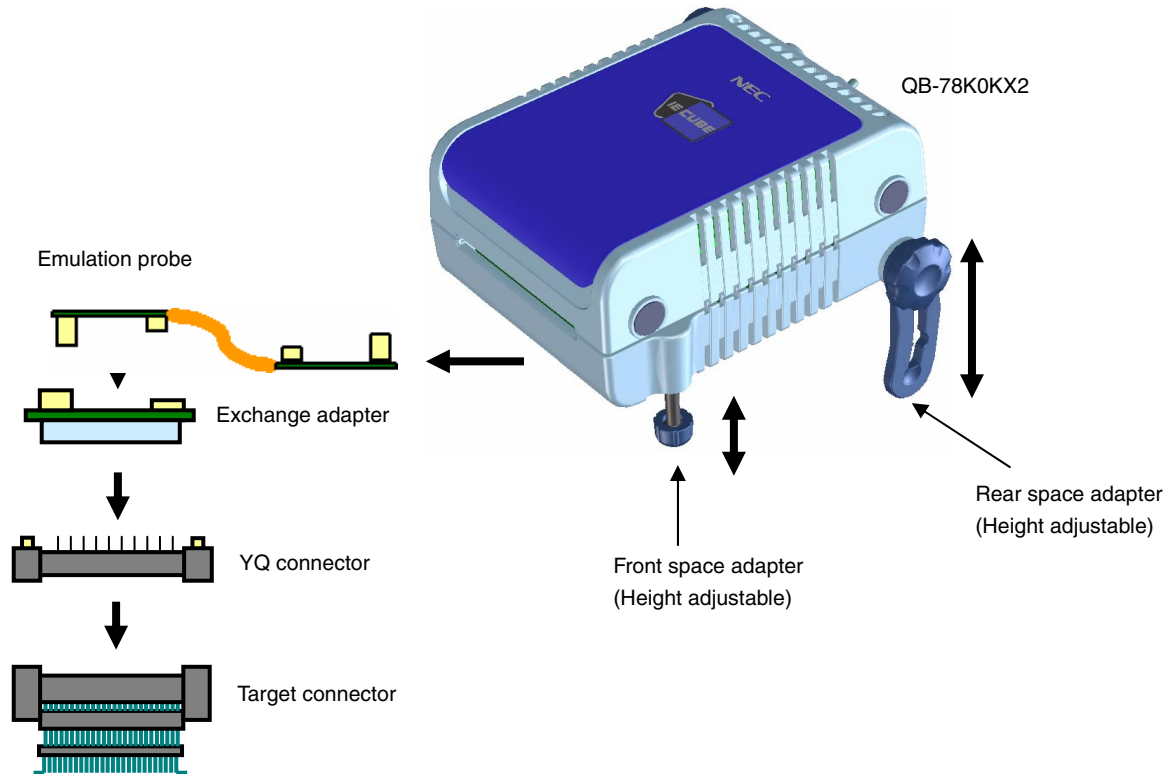
Figure 2-7. Where GND Wire Can Be Connected



(c) Ensuring isolation

When connecting the target system to the QB-78K0KX2 using an emulation probe, adjust the height using the front space adapter or rear space adapter of the QB-78K0KX2 and ensure isolation from the target system.

Figure 2-8. Connection Using Emulation Probe

**(d) Precautions related to emulation probe**

The following precautions pertain to using the emulation probe.

- <1> Be careful that stress of the emulation probe is not placed on the target connector. Moreover, when removing the emulation probe, remove it slowly while pressing down on the exchange adapter with a finger so that there is no stress on the target connector.
- <2> Be sure to connect the GND wire of the emulation probe to the QB-78K0KX2 and the target system. If not, the impedance of the cable becomes unstable, resulting in the lowering of signal transmission characteristics or distortion of the output waveform for an input waveform.

2.7 Notes on Power Supply and GND Pin Connection

For power supplies and GND pins of the target device, be sure to connect all pins to each power supply or GND.

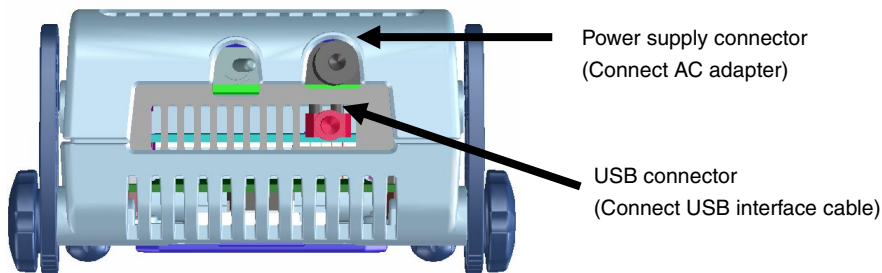
2.8 Connecting USB Interface Cable and AC Adapter

Plug the USB interface cable supplied with the QB-78K0KX2 into the USB connector of the host machine, and plug the other side into the USB connector on the rear of the QB-78K0KX2.

Plug the AC adapter supplied with the QB-78K0KX2 into a receptacle and plug the other side into the power supply connector on the rear of the QB-78K0KX2.

For QB-78K0KX2 connector positions, see **Figure 2-9**. There are three types of AC adapter plug. Use the one that has a suitable shape.

Figure 2-9. Connector Positions



2.9 Switching Power On and Off

Be sure to switch the power on and off according to the following procedures.

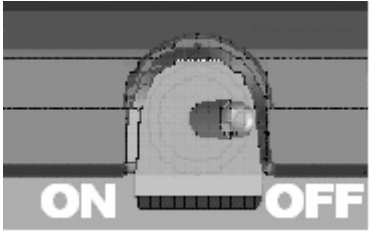
- | | |
|--|---|
| • Switching power on | • Switching power off |
| <1> QB-78K0KX2 power on | <1> Debugger termination |
| <2> Target system power on ^{Note} | <2> Target system power off ^{Note} |
| <3> Debugger startup | <3> QB-78K0KX2 power off |

Note In the procedures, <2> is unnecessary if the target system is not connected.

Caution If the wrong sequence was used for the operation, the target system or QB-78K0KX2 may fail.

CHAPTER 3 SETTINGS AT PRODUCT SHIPMENT

Table 3-1. Settings at Shipment

| Item | Setting | Remarks |
|--------------|---|---|
| OSC1 | Not mounted | Oscillator can be mounted ^{Note} . |
| Power switch |  | Set to OFF at shipment. |

Note The oscillation circuit using an oscillation cannot be used.

CHAPTER 4 DIFFERENCES BETWEEN TARGET INTERFACE CIRCUIT AND TARGET DEVICE

This chapter explains the differences between the signal lines of a target interface circuit of the QB-78K0KX2 and the signal lines of a target device

Although the target device is a CMOS circuit, the target interface circuit of the QB-78K0KX2 consists of an emulation circuit that depends on the emulation CPU, TTL, CMOS-IC, or other.

When the target system is debugged by connecting it to the QB-78K0KX2, the QB-78K0KX2 emulates just as if the actual target device were operating on the target system.

However, small differences arise because the QB-78K0KX2 actually is emulating.

- (1) Signals input and output by emulation CPU (FPGA, μ PD78F0547)
- (2) Other signals

The circuits of the QB-78K0KX2 for the signals in (1) and (2) above are shown below by target device.

4.1 For 78K0/KB2 Emulation

For the signals in (1) and (2) below, see **Figure 4-1 Emulation Circuit Equivalent Circuit 1**.

(1) Signals input and output by emulation CPU (FPGA, μ PD78F0547)

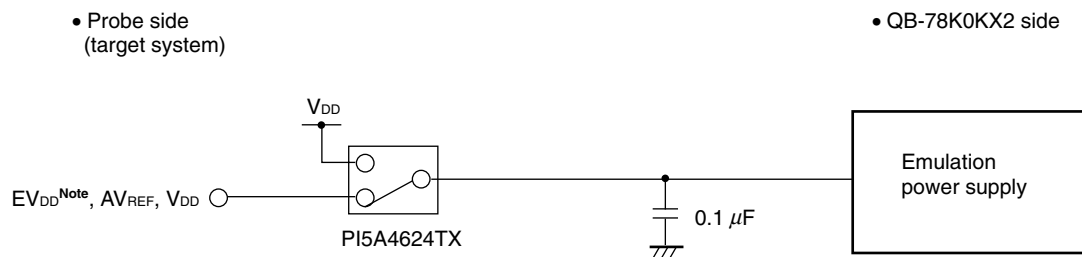
- P01, P00
- P17 to P10
- P23 to P20
- P33 to P30
- P61, P60
- P121, P120
- X2, RESET, V_{SS}, IC/FLMD0, EV_{SS}^{Note}

(2) Other signals

- V_{DD}, AV_{SS}, AV_{REF}, EV_{DD}^{Note}
- NC^{Note}
- REGC

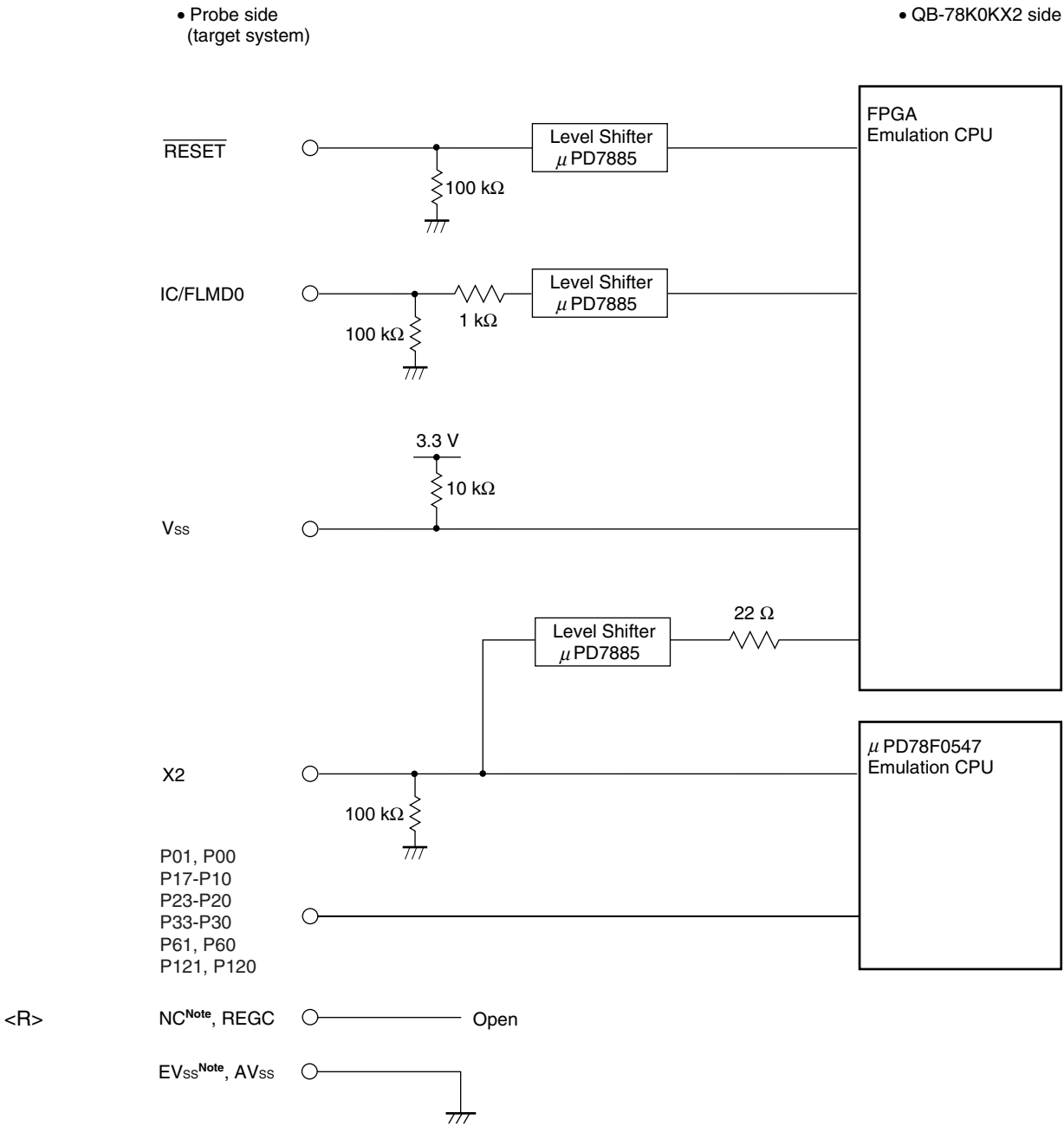
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Figure 4-1. Emulation Circuit Equivalent Circuit 1 (1/2)



Note EV_{DD}, EV_{SS}, and NC are only 36FC package.

Figure 4-1. Emulation Circuit Equivalent Circuit 1 (2/2)



Note EV_{DD}, EV_{SS}, and NC are only 36FC package.

4.2 For 78K0/KC2 Emulation

For the signals in (1) and (2) below, see **Figure 4-2 Emulation Circuit Equivalent Circuit 2**.

(1) Signals input and output by emulation CPU (FPGA, μ PD78F0547)

- P01, P00
- P17 to P10
- P27 to P20
- P33 to P30
- P41, P40
- P63 to P60
- P75 to P70
- P123, P121, P120
- P130
- P140
- X2, XT2, $\overline{\text{RESET}}$, V_{SS} , IC/FLMD0

(2) Other signals

- V_{DD} , AV_{SS} , AV_{REF}
- REGC

<R>

Figure 4-2. Emulation Circuit Equivalent Circuit 2 (1/2)

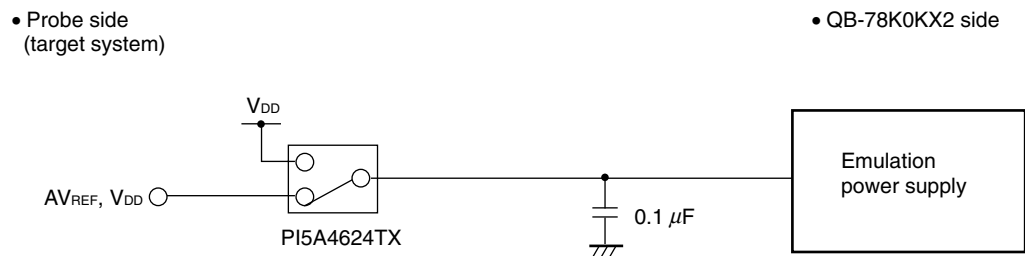
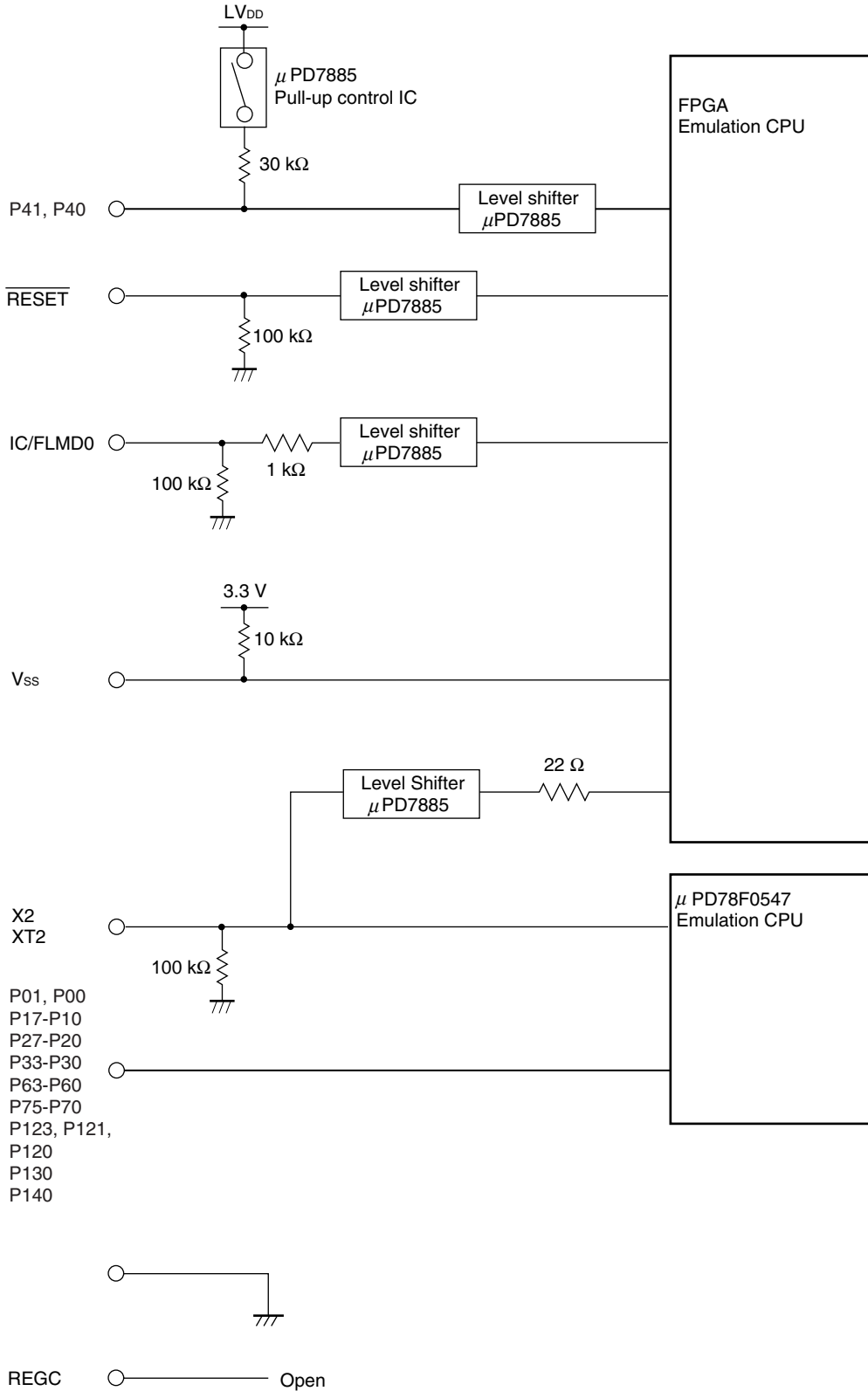


Figure 4-2. Emulation Circuit Equivalent Circuit 2 (2/2)

• Probe side
(target system)

• QB-78K0KX2 side



<R>

REGC ○ — Open

4.3 For 78K0/KD2 Emulation

For the signals in (1) and (2) below, see **Figure 4-3 Emulation Circuit Equivalent Circuit 3**.

(1) Signals input and output by emulation CPU (FPGA, μ PD78F0547)

- P03 to P00
- P17 to P10
- P27 to P20
- P33 to P30
- P41, P40
- P63 to P60
- P77 to P70
- P123, P121, P120
- P130
- P140
- X2, XT2, $\overline{\text{RESET}}$, V_{SS} , IC/FLMD0

(2) Other signals

- V_{DD} , AV_{SS} , AV_{REF}
- REGC

<R>

Figure 4-3. Emulation Circuit Equivalent Circuit 3 (1/2)

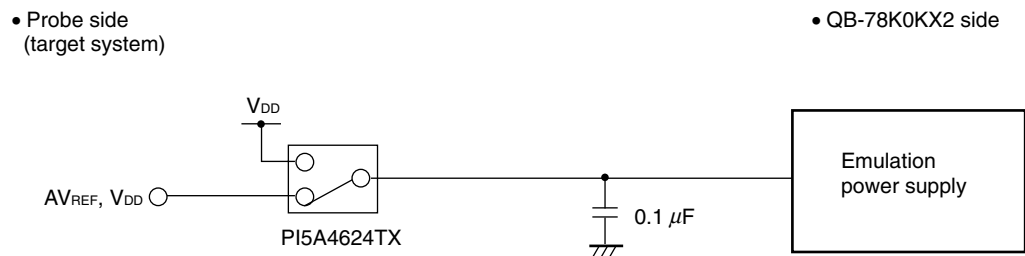
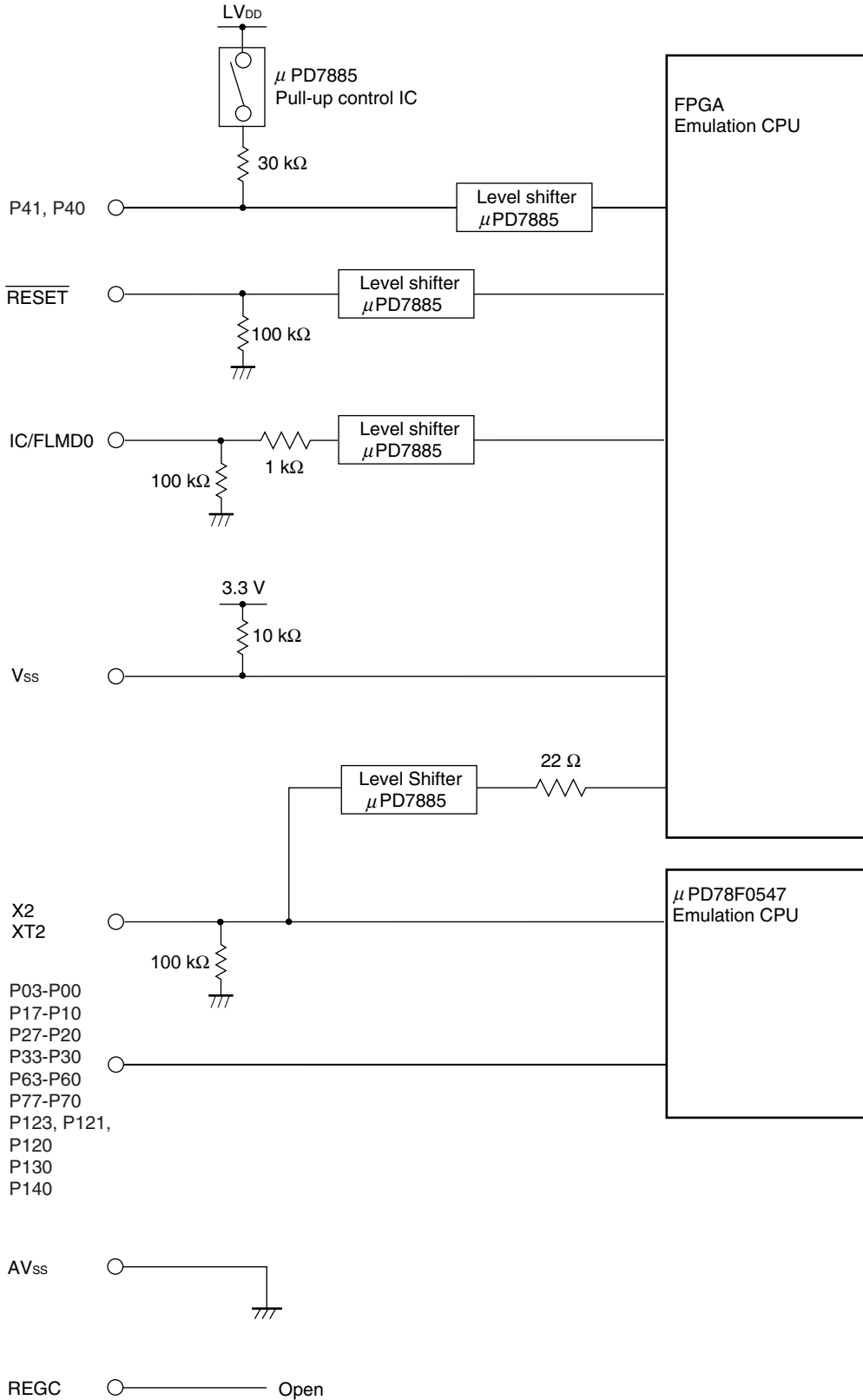


Figure 4-3. Emulation Circuit Equivalent Circuit 3 (2/2)

• Probe side
(target system)

• QB-78K0KX2 side



<R>

4.4 For 78K0/KE2 Emulation

For the signals in (1) and (2) below, see **Figure 4-4 Emulation Circuit Equivalent Circuit 4**.

(1) Signals input and output by emulation CPU (FPGA, μ PD78F0547)

- P06 to P00
- P17 to P10
- P27 to P20
- P33 to P30
- P43 to P40
- P53 to P50
- P63 to P60
- P77 to P70
- P123, P121, P120
- P130
- P141, P140
- X2, XT2, $\overline{\text{RESET}}$, V_{SS}, IC/FLMD0

(2) Other signals

- V_{DD}, EV_{SS}, EV_{DD}, AV_{SS}, AV_{REF}
- REGC

<R>

Figure 4-4. Emulation Circuit Equivalent Circuit 4 (1/2)

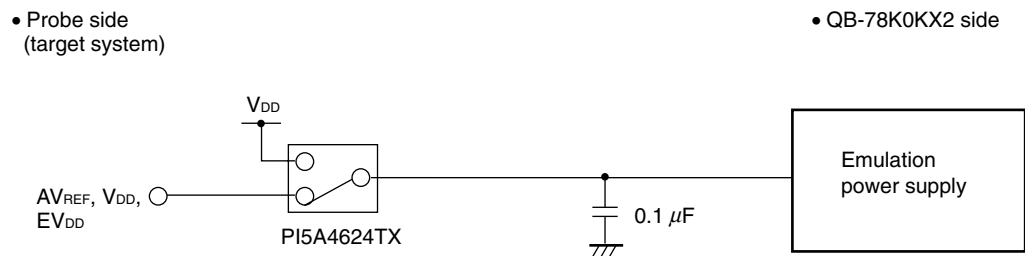
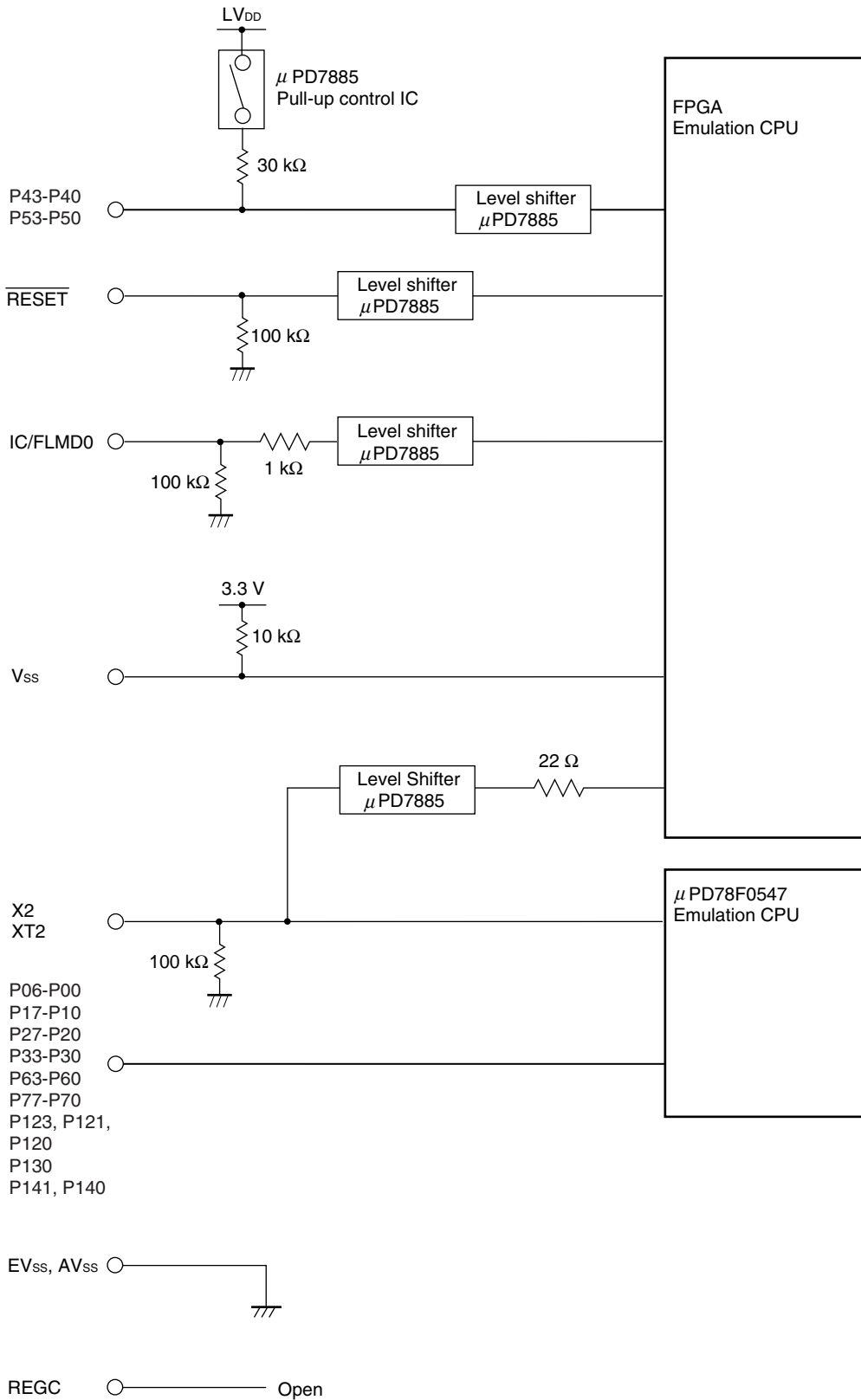


Figure 4-4. Emulation Circuit Equivalent Circuit 4 (2/2)

• Probe side
(target system)

• QB-78K0KX2 side



<R>

4.5 For 78K0/KF2 Emulation

For the signals in (1) and (2) below, see **Figure 4-5 Emulation Circuit Equivalent Circuit 5**.

(1) Signals input and output by emulation CPU (FPGA, μ PD78F0547)

- P06 to P00
- P17 to P10
- P27 to P20
- P33 to P30
- P47 to P40
- P57 to P50
- P67 to P60
- P77 to P70
- P123, P121, P120
- P130
- P145 to P140
- X2, XT2, $\overline{\text{RESET}}$, V_{SS}, IC/FLMD0

(2) Other signals

- V_{DD}, EV_{SS}, EV_{DD}, AV_{SS}, AV_{REF}
- REGC

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Figure 4-5. Emulation Circuit Equivalent Circuit 5 (1/2)

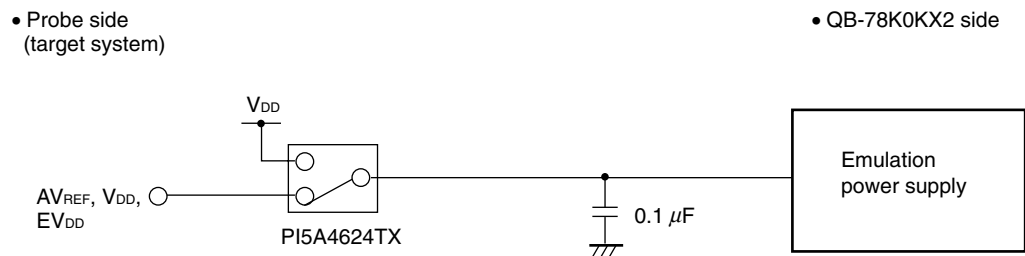
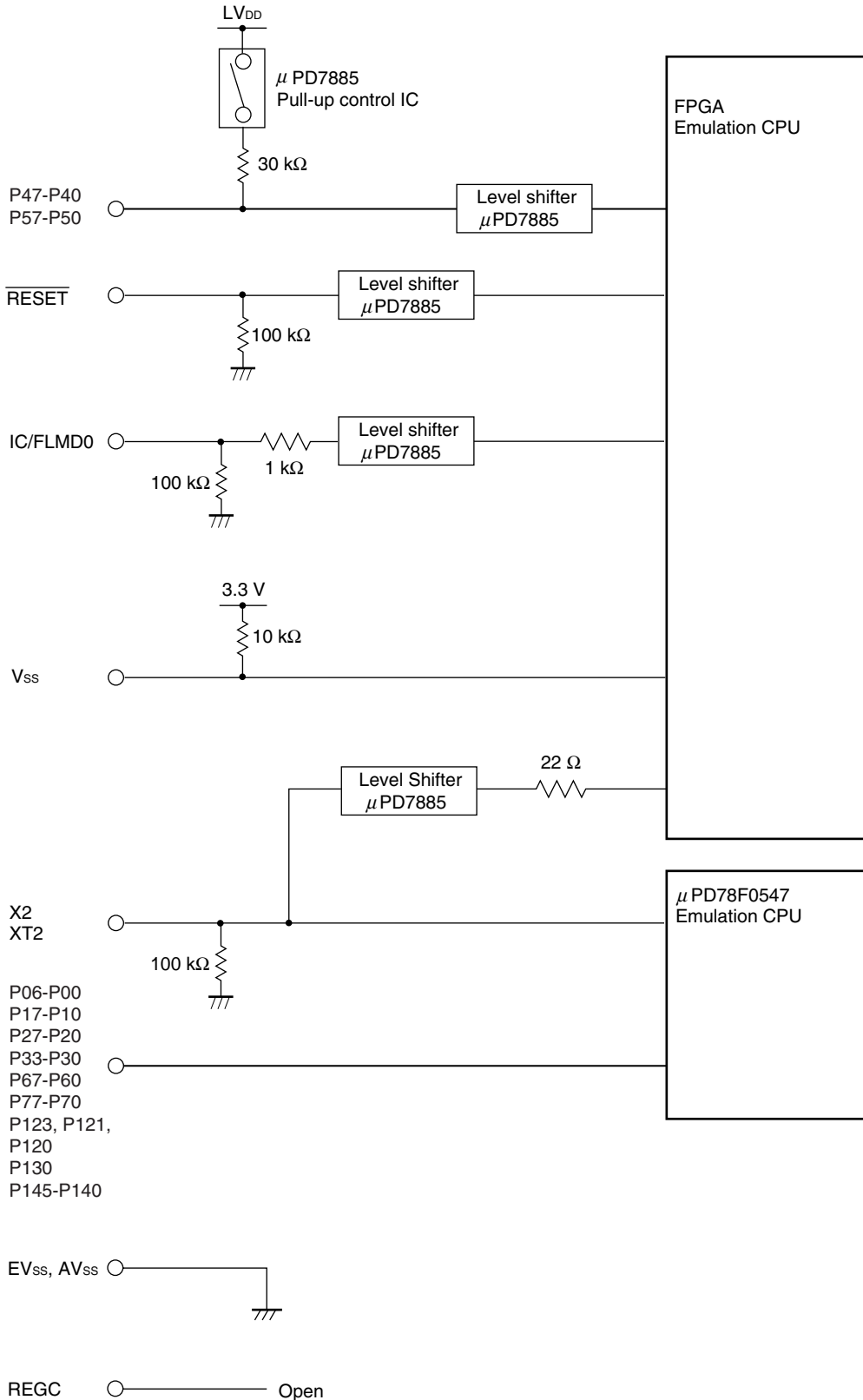


Figure 4-5. Emulation Circuit Equivalent Circuit 5 (2/2)

• Probe side
(target system)

• QB-78K0KX2 side



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CHAPTER 5 NOTES

Observe the following notes.

- Do not turn off the target power supply (do not allow it to become lower than the POC voltage) during a break (power supply can be turned off only during RUN).
- When inputting the external clock, input the square waveform with the same potential as the target device to the clock pins (X2, XT2).
- Even when using the product without connecting a target system, connect and use the emulation probe and exchange adapter.
If the product is used without connecting the emulation adapter and exchange adapter, a warning window is displayed but use is possible.
- A WDT reset is not generated when an area for which the capacities of the internal ROM, internal high-speed ROM, and internal expansion RAM are not set with the IMS and IXS registers is illegally accessed. Emulation is performed with a fail-safe break.
- Since a voltage around 1.7 V is set as a threshold value for POC detection by the emulator, it is different from the POC detection voltage of the device.
- The QB-78K0KX2 may be damaged if AV_{REF} is applied before the target powers V_{DD} and EV_{DD} are applied.

APPENDIX A REVISION HISTORY

The following table shows the revision history up to this edition. The “Applied to:” column indicates the chapters of each edition in which the revision was applied.

(1/2)

| Edition | Major Revision from Previous Edition | Applied to: |
|-------------|--|---|
| 2nd edition | Deletion of CHAPTER 6 RESTRICTIONS | throughout |
| | Table 1-1. QB-78K0KX2 Hardware Specifications • Change of specification in operating frequency | CHAPTER 1 GENERAL |
| | Table 1-2. QB-78K0KX2 System Specifications • Change of specification in emulation memory capacity | |
| | 1.3 System Configuration • Change of Table 1-3. Devices Subject to Emulation by 78K0/Kx2 | |
| | 2.1 Names and Functions of Hardware • Change of bottom view in Figure 2-1. Names of Parts of QB-78K0KX2 • Change of title of (3) | CHAPTER 2 SETUP PROCEDURE |
| | CHAPTER 4 DIFFERENCES BETWEEN TARGET INTERFACE CIRCUIT AND TARGET DEVICE • Addition and change of description | CHAPTER 4 DIFFERENCES BETWEEN TARGET INTERFACE CIRCUIT AND TARGET DEVICE |
| | CHAPTER 5 NOTES • Addition of description | CHAPTER 5 NOTES |
| 3rd edition | Table 1-3. Devices Subject to Emulation by QB-78Kx2 • Addition of package in KB2 series. | CHAPTER 1 GENERAL |
| | 1.3 System Configuration • Addition and change of description | |
| | 2.1 Names and Functions of Hardware • Addition of note in (3) CN4 | CHAPTER 2 SETUP PROCEDURE |
| | 2.5.1 Mounting NQ in target system • Change of solder reflow of soldering conditions | |
| | CHAPTER 3 SETTINGS AT PRODUCT SHIPMENT • Addition of note of OSC1 Remarks in Table 3-1. Settings at Shipment | CHAPTER 3 SETTINGS AT PRODUCT SHIPMENT |
| | APPENDIX A NOTES ON TARGET SYSTEM DESIGN • Addition of figure of 36-pin MC package, 36-pin FC package, 64-pin FC package, and 64-pin GA package etc. | APPENDIX A NOTES ON TARGET SYSTEM DESIGN |
| | APPENDIX B PACKAGE DRAWINGS • Addition of the figure in connection with each system configuration of 36-pin MC package, 36-pin FC package, 64-pin FC package, and 64-pin GA package etc. | APPENDIX B PACKAGE DRAWINGS |
| 4th edition | Deletion of 1.3.1 AC adapter | CHAPTER 1 GENERAL |

| Edition | Major Revision from Previous Edition | Applied to: |
|-------------|---|---|
| 5th edition | 1.3 System Configuration <ul style="list-style-type: none"> • Change of Table 1-9. Target Connectors and Table 1-10. Mount Adapters • Addition of Remark | CHAPTER 1 GENERAL |
| | 1.4 Package Contents <ul style="list-style-type: none"> • Change of Products supplied with QB-78K0KX2-ZZZ and Products supplied with QB-78K0KX2-T64GC | |
| | Change of 2.3 Clock Settings | CHAPTER 2 SETUP PROCEDURE |
| | 4.1 For 78K0/KB2 Emulation to 4.5 For 78K0/KF2 Emulation <ul style="list-style-type: none"> • Change of (2) Other signals | CHAPTER 4 DIFFERENCES BETWEEN TARGET INTERFACE CIRCUIT AND TARGET DEVICE |
| | Deletion of APPENDIX A NOTES ON TARGET SYSTEM DESIGN and APPENDIX B PACKAGE DRAWINGS from a previous edition | - |

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